

UH3B, UH3C & UH3D

Vishay General Semiconductor

Surface Mount Ultrafast Rectifier



DO-214AB (SMC)

PRIMARY CHARACTERISTICS					
I _{F(AV)}	3.0 A				
V_{RRM}	100 V, 150 V, 200 V				
I _{FSM}	80 A				
t _{rr}	25 ns				
V _F at I _F = 3.0 A	0.75 V				
T _J max.	175 °C				

FEATURES

- · Low profile package
- · Ideal for automated placement
- · Oxide planar chip junction
- Ultrafast recovery times for high frequency
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Solder dip 260 °C, 40 s
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in secondary rectification and freewheeling for ultrafast switching speeds of ac-to-ac and dc-to-dc converters in high temperature conditions for both consumer and automotive applications.

MECHANICAL DATA

Case: DO-214AB (SMC)

Epoxy meets UL 94 V-0 flammability rating

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test, HE3 suffix for high reliability grade (AEC-Q101 qualified), meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	UH3B	UH3C	UH3D	UNIT
Device marking code		НВ	HC	HD	
Maximum repetitive peak reverse voltage	V _{RRM}	100	150	200	V
Maximum average forward rectified current (Fig. 1)	I _{F(AV)}	2.5 ⁽¹⁾ 3.0 ⁽²⁾			А
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	80			А
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 175			°C

Notes:

- (1) Free air, mounted on recommended copper pad area
- (2) Units mounted on P.C.B. with 0.31" x 0.31" (8.0 mm x 8.0 mm) copper pad area

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage (1)	I _F = 1.5 A I _F = 3.0 A	T _A = 25 °C	V	0.85 0.95	- 1.05	V
	I _F = 1.5 A I _F = 3.0 A	T _A = 125 °C	V _F	0.65 0.75	- 0.90	
Reverse current (2)	Rated V_R $ T_A = 25 ^{\circ}C $ $ T_A = 125 ^{\circ}C $ $ I_R$		I _R	- 15	5 100	μΑ
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A	T 05 °C		14	25	
Typical reverse recovery time	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$	T _A = 25 °C	t _{rr}	23	40	ns
Typical softness factor (t _b /t _a)			S	0.2	-	
Typical reverse recovery current	$I_F = 3.0 \text{ A}, \text{ dI/dt} = 200 \text{ A/}\mu\text{s},$ $V_B = 200 \text{ V}$	T _A = 125 °C	I _{RM}	5.0	7.0	Α
Typical stored charge	'n =		Q _{rr}	60	-	nC
Typical junction capacitance	4.0 V, 1 MHz		CJ	42	-	pF

Notes:

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	DL UH3B UH3C UH3D		UH3D	UNIT
Typical thermal resistance (1)	$R_{ hetaJA} \ R_{ hetaJM}$	95 12		°C/W	

Note:

(1) Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction to ambient, $R_{\theta JM}$ - junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
UH3D-E3/57T	0.236	57T	850	7" diameter plastic tape and reel	
UH3D-E3/9AT	0.236	9AT	3500	13" diameter plastic tape and reel	
UH3DHE3/57T (1)	0.236	57T	850	7" diameter plastic tape and reel	
UH3DHE3/9AT (1)	0.236	9AT	3500	13" diameter plastic tape and reel	

Note:

(1) AEC-Q101 qualified





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RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

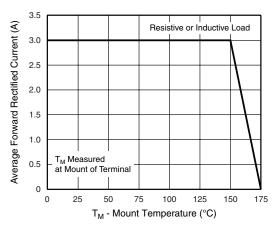


Figure 1. Maximum Forward Current Derating Curve

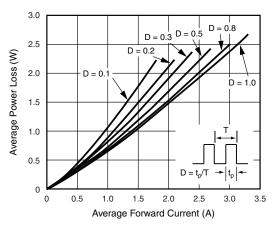


Figure 2. Forward Power Loss Characteristics

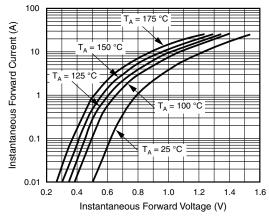


Figure 3. Typical Instantaneous Forward Characteristics

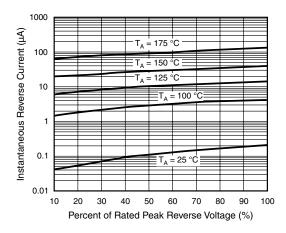


Figure 4. Typical Reverse Characteristics

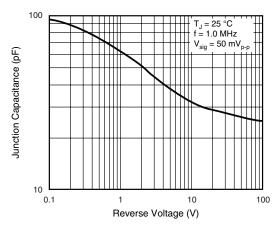


Figure 5. Typical Junction Capacitance

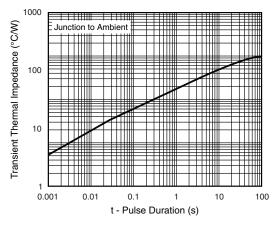


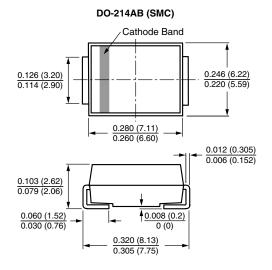
Figure 6. Typical Transient Thermal Impedance

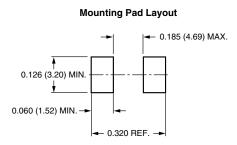
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)









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